

# Harvatek Surface Mount CHIP LEDs Data Sheet B3DJ3BRG-05C-000113

#### **Features**

- •Support signal reshaping to pass control waveforms to next adjacent driver
- Cascading port transmission by a single data line
- •Support BI by-pass data line to prevent transmission failure from malfunction DI line
- •Built-in current regulator, three-way drive.
- •Optional- Optional maximal drive current: 5mA
- •256-step gray-scale output to allow 16,777,216 color display
- •Support 8192-level GAMMA 2.8 resolution
- •13-bit PWM for each of RGB outputs
- •Operating voltage 4.5~5.5V

### **Applications**

- •Decorative LED lighting
- LED video display



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- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
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## **Product Specifications**

Specification	Material	Quantity
Red : 40~120 mcd		
Green : 60~180 mcd		
Blue : 15~60 mcd		
IC@5V, R/G/B@5mA		
Ts= 25° C; Tolerance ±10%		
Red : 618~625 nm		
Green : 520~535 nm		
Blue : 460~472 nm		
IC@5V, R/G/B@5mA		
Ts= 25° C; Tolerance ±10%		
5V_DC		
120°		
Clear	Ероху	
	Conductive black tape	3000 ea/reel
	Conductive black	
HT standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
HT standard	Paper	Non-specified
	Red: 40~120 mcd  Green: 60~180 mcd  Blue: 15~60 mcd  IC@5V, R/G/B@5mA  Ts= 25° C; Tolerance ±10%  Red: 618~625 nm  Green: 520~535 nm  Blue: 460~472 nm  IC@5V, R/G/B@5mA  Ts= 25° C; Tolerance ±10%  5V_DC  120°  Clear  HT standard  220x240mm	Red: 40~120 mcd  Green: 60~180 mcd  Blue: 15~60 mcd  IC@5V, R/G/B@5mA  Ts= 25° C; Tolerance ±10%  Red: 618~625 nm  Green: 520~535 nm  Blue: 460~472 nm  IC@5V, R/G/B@5mA  Ts= 25° C; Tolerance ±10%  5V_DC  120°  Clear  Epoxy  Conductive black tape  Conductive black  HT standard  Paper  220x240mm  Aluminum laminated bag/ no-zipper

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note: This is shipped test conditions

\*Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

#### ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

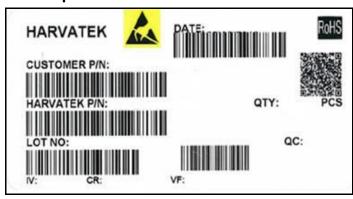
be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

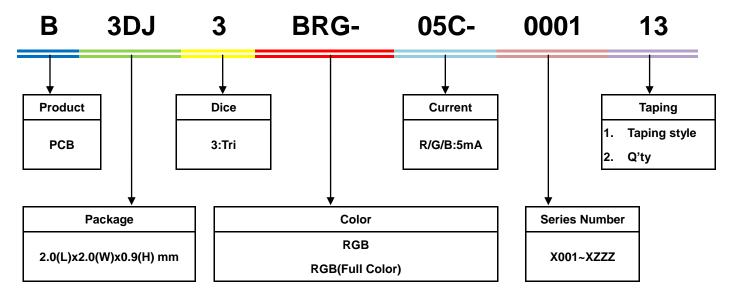
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# **Label Specifications**



### Harvatek P/N:



### Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	Α	2	2	L	1	2
Cod	le 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special cod	e
		2010-A		1:A					
		2011-B		2:B					
		2012-C	1:Jan.	3:C					
			2:Feb.	***					
(atama) Ta		2018-I/J	11900	26:Z		77		000 777	
internal in	acing Code	2019-K	A:Oct.	27:7	01-	-ZZ		000~ZZZ	
		1.00	B:Nov.	28:8					
		2022-N	C:Dec.	29:9					
		2023-P	200000000000000000000000000000000000000	30:3					
		***		31:4					

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# **Specifications Range**

# ■Luminous Intensity (Iv) :

Color	Spec. Range
R	40-120 mcd
G	60-180 mcd
В	15-60 mcd

Note: It maintains a tolerance of ±10% on luminous intensity

# **■**Wavelength:

Color	Spec. Range
R	618-625 nm
G	520-535 nm
В	460-472 nm

Note: It maintains a tolerance of  $\pm 0.5$ nm on Wavelength Bin

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### **Product Features**

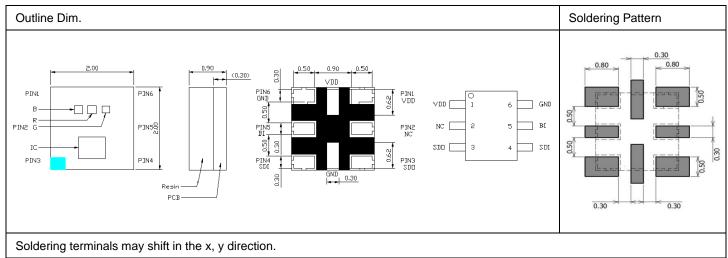
# **Electro-Optical Characteristics**

(T<sub>Soldering</sub>, 25 °C)

Ossiss	Facittica Octor	NA-4:I	Wa	velength λ	(nm)	I <sub>V</sub> (mcd)	Viewing
Series	Emitting Color	Material	$\lambda_{D}$	$\lambda_{P}$	Δλ	Typical	Angle $2\theta \frac{1}{2}$
	R	AllnGaP	624	630	18	65	120
B3DJ3BRG	G	InGaN	523	518	35	85	120
	В	InGaN	470	465	25	20	120

# Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)



### Absolute Maximum Ratings (unless otherwise specified, Temperature=25°C)

(T<sub>Soldering</sub> 25 °C)

Characteristic	Symbol	Rating	Unit
Supply Voltage	VDD	6.5	V
Power Dissipation	PD	<400	mW
Maximum Output Current	ILEDOUT	25	mA
Welding Temperature	TM	300(8S)	°C
Operating Temperature Range	TOPR	-40~85	°C
Storage Temperature Range	TSTO	-65~120	°C

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# **Electrical Characteristics**

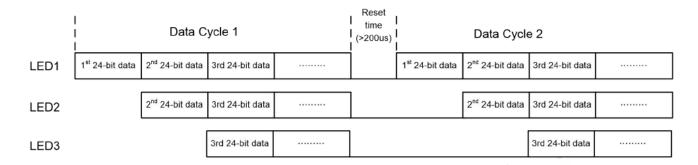
Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Supply Voltage	VDD	4.5	5	5.5	V	
Operation Current	I <sub>DD</sub>			3	mA	R, G, B no load
Input High "H" of DI, BI	V <sub>IH</sub>	0.7*VDD		VDD+0.4	V	
Input Low "L" of DI, BI	V <sub>IL</sub>	-0.4		0.2*VDD	V	
Output High "H" of DO	V <sub>OH</sub>	4.5			V	IOH=4mA
Output Low "L" of DO	V <sub>OL</sub>			0.4	V	IOL=4mA
R , G , B Sink Current	I <sub>SINK</sub>	4.75	5	5.25	mA	Vo=VDD-3.0V @VDD=5V
DI, BI Input leakage	I <sub>leak</sub>			1	uA	DI, BI=VDD
R, G, B off leakage				1		PWM=0(off),
current	l <sub>off</sub>			1	uA	@R, G, B =5V

Parameter	Symbol	Min.	Тур.	Max.	Units	Note
Propagation	tPLZ			300	ns	DI $\rightarrow$ DO, CL=15pF,
delay time	tPZL			300	ns	RL=10KΩ
Rising time	tTZH			200	ns	D C D-FmA CL-20nF
Falling time	tTHZ			200	ns	R, G, B=5mA, CL=30pF

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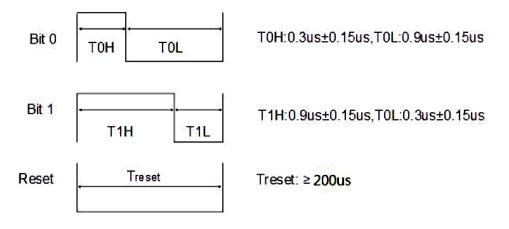


#### **Data Transfer Protocol**



The single wire data transfer protocol supports 24-bit data for each LED RGB display data refresh. The IC receives 24-bit data and passes the remaining data to next LED. The 24-bit data consist of blue, red and green data, each with 8-bit width, and are transferred with MSB first.

The transferred data are recognized based on the pulse widths received by the IC. A low bit 0 is represented by a 0.3us high pulse followed by a 0.9us low pulse. A high bit 1 is represented by a 0.9us high pulse followed by a 0.3us low pulse. A low pulse  $\geq$  200us is used to issue a reset command to the IC to start a new cycle of serial commands.



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#### **Precaution for Use**

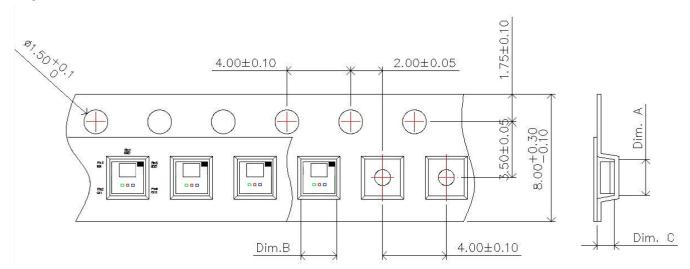
- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 168hours after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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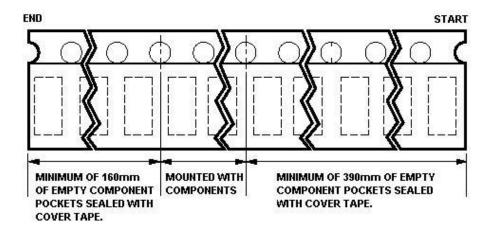


# **Packaging**

# **Tape Dimension**



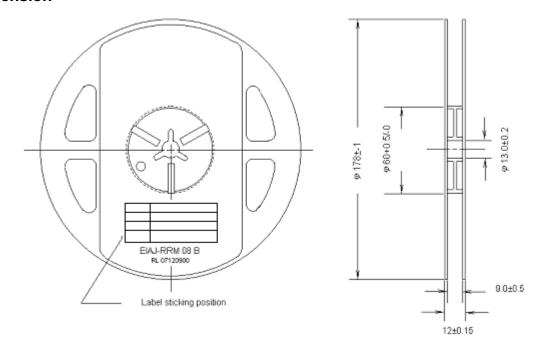
Dim. A	Dim. B	Dim. C	Q'ty/Reel
2.15±0.10	2.15±0.10	1.05±0.10	3К



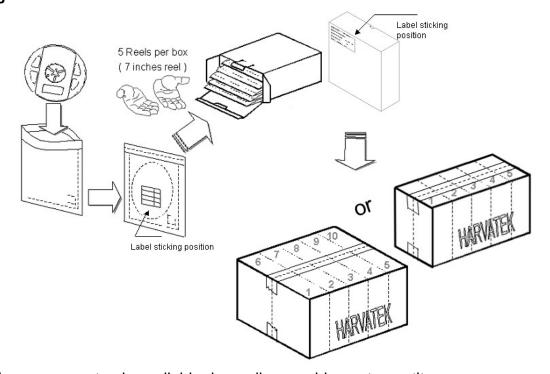
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# **Reel Dimension**



# **Packing**



5 or 10 boxes per carton is available depending on shipment quantity.

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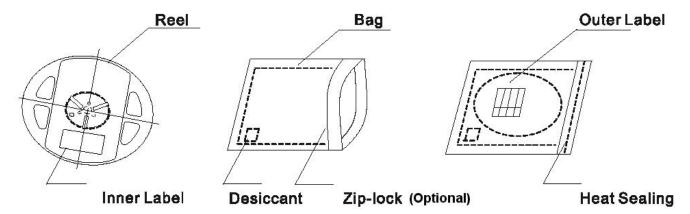


#### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



# **Baking**

Baking before soldering is recommended when the package has been unsealed for 72hours. The conditions are as followings:

- 1.  $60\pm3^{\circ}$ C ×(12~24hrs)and<5%RH, taped reel type.
- 2.  $100\pm3^{\circ}$  × (45min~1hr), bulk type.
- 3.  $130\pm3^{\circ}$ C×(15min~30min), bulk type.

#### **Precautions**

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

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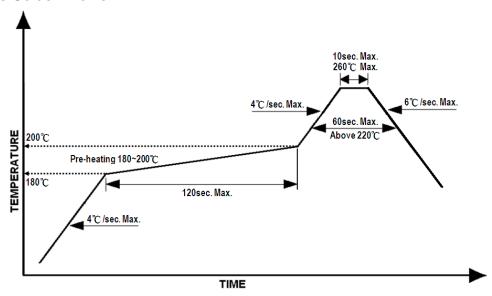


#### **Reflow Soldering**

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220°C ,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter</li>
- Curing: 100 °C max, <3min</li>

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### Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

# **Revise History**

Rev.	Descriptions	Date	Page
-	-	02/07/2020	-

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